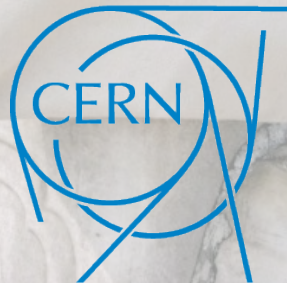


Precision timing calorimetry with the upgraded CMS ECAL

P. Meridiani
(CERN & INFN Roma)
for the CMS Collaboration

PANIC2017 Conference, Beijing
02/09/2017



CMS ECAL: precision timing with PbWO_4 crystals

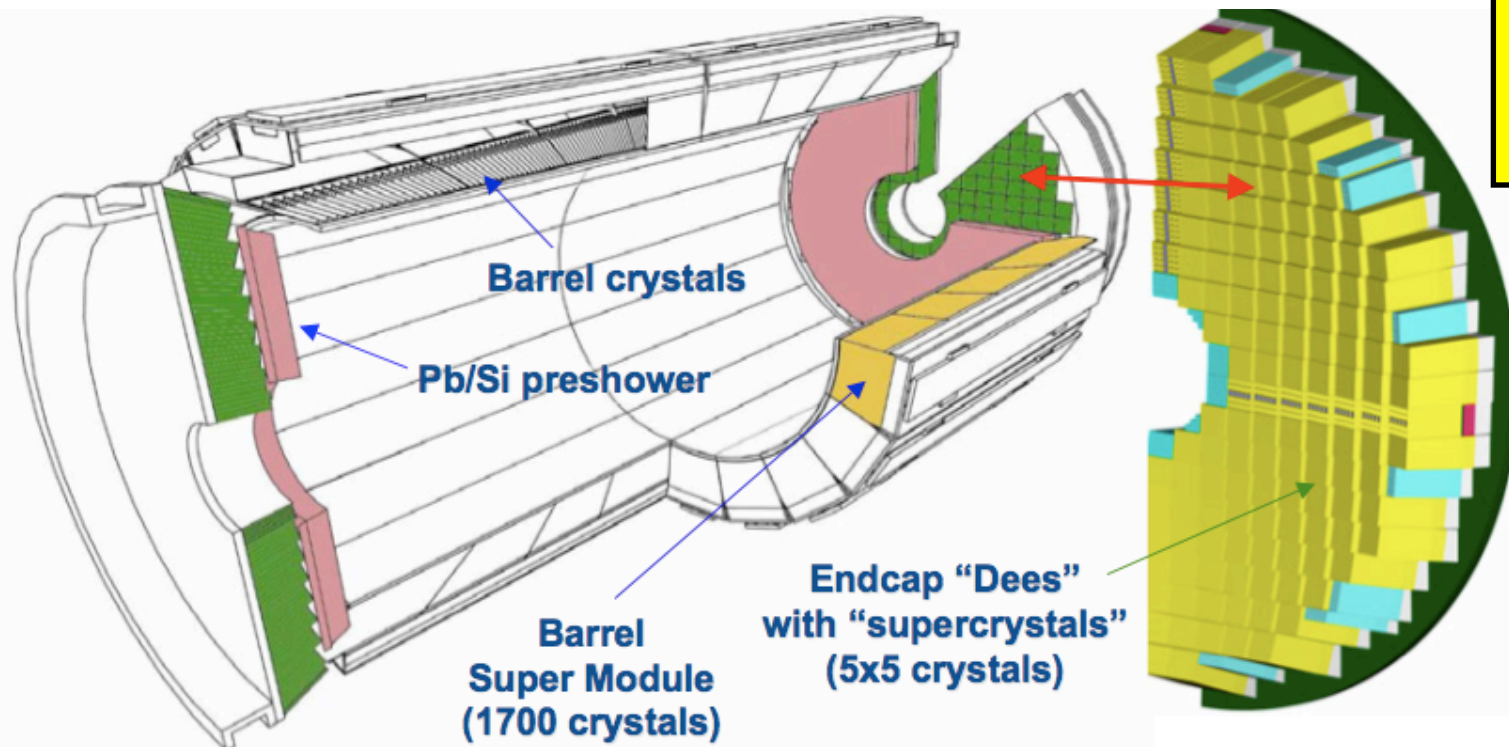
Physics at HL-LHC: precision timing and pile-up

CMS ECAL barrel upgrade for HL-LHC

test beam results

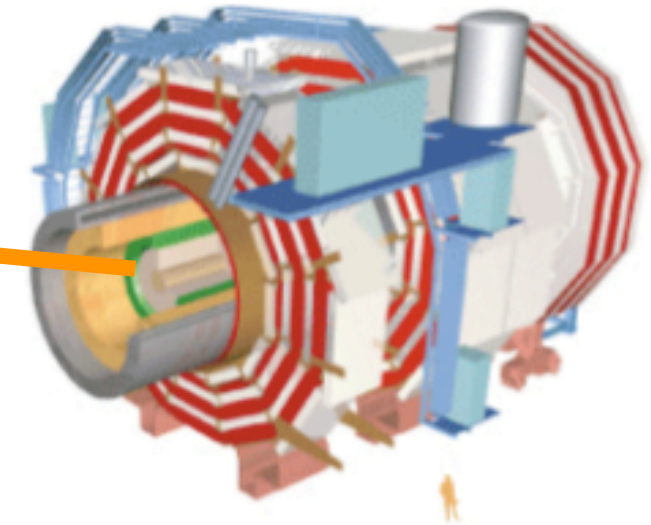
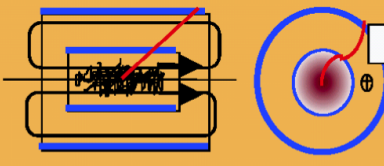
Summary

CMS ECAL



Tracker coverage $|\eta| < 2.5$
ECAL placed inside the coil
Designed for 14 TeV,
 $L=10^{34} \text{cm}^{-2}\text{s}^{-1}, 500 \text{fb}^{-1}$

3.8 T magnetic field
Magnet radius 6 m



Homogeneous PbWO_4 crystals

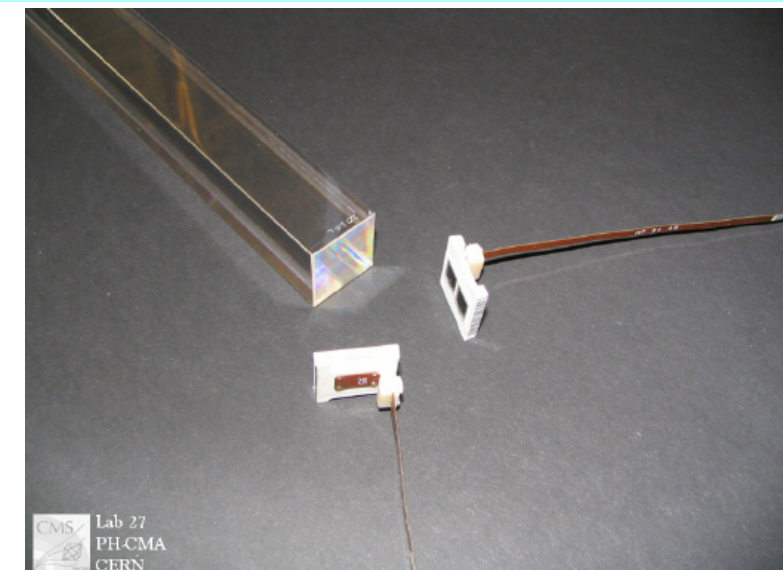
Designed to optimise energy resolution: $< 1\%$ at 60 GeV ($H \rightarrow \gamma\gamma$ discovery in 2012)
Barrel crystals: $2.2 \times 2.2 \times 23 \text{ cm}^3$ (PbWO_4 $X_0=0.89\text{cm}$)
Light yield 4pe/MeV on APD pair

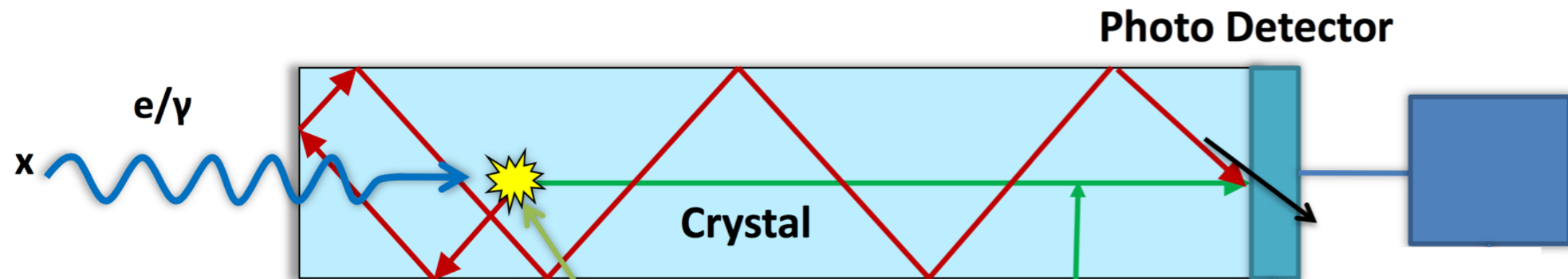
No longitudinal segmentation:

cannot measure γ direction without interaction vertex position

Barrel - Avalanche Photo-Diodes (APD)

Gain: 50 QE $\sim 75\%$ @ $\lambda_{\text{peak}}=420\text{nm}$
 $\Delta G/\Delta T = -2.4\%/^{\circ}\text{C}$ $\Delta G/\Delta V = 3.1\%/V$





Several ingredients determine the time resolution of an electromagnetic shower in a homogeneous crystal calorimeter

- **Intrinsic EM shower fluctuations**

- longitudinal shower fluctuations

- optical transit time spread: scintillation rise/decay time, light propagation

- **Photodetector + electronics**

- photodetector: rise time, transit time

- noise: dark current, electronic noise

- **DAQ**

- clock distribution

TIMING WITH CMS ECAL

Original design requirements on ECAL timing to ensure good energy resolution

stability within 1 ns

PbWO₄ is a fast scintillator

90% of light within 25 ns

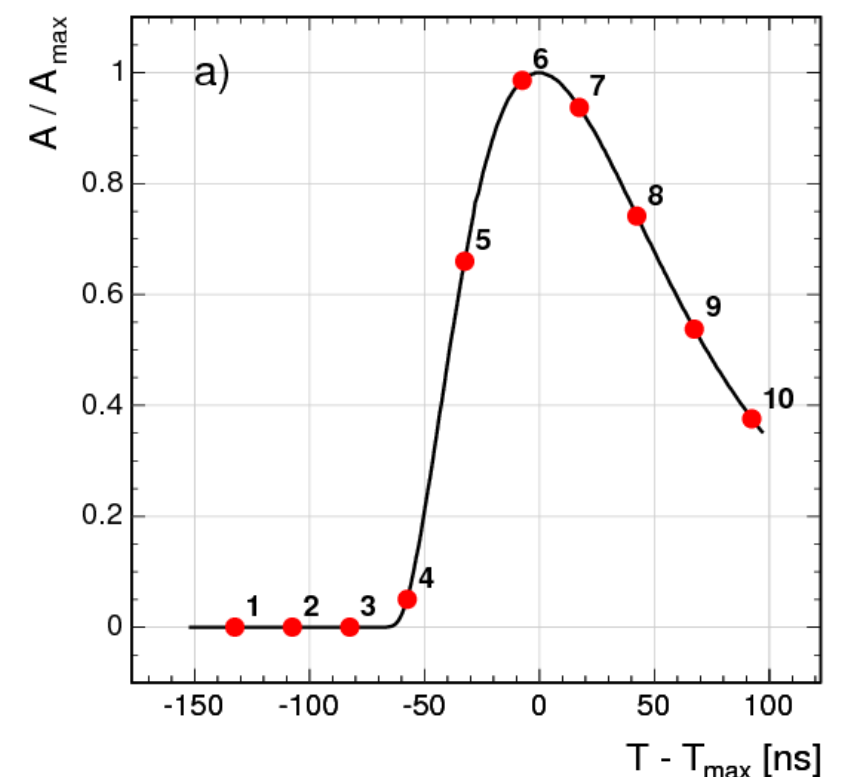
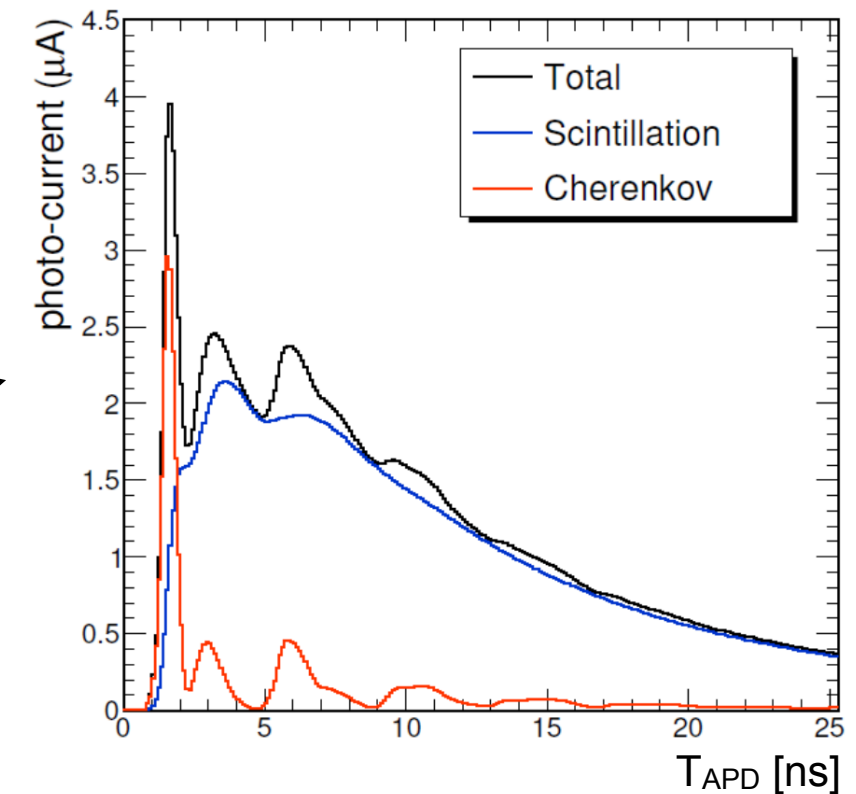
~10% contribution from Cherenkov

Timing information extracted from reconstructed pulse shape

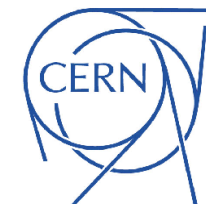
electronics optimised for LHC Phase I conditions

43 ns electronics shaping time

sampling at 40 MHz



CURRENT ECAL TIMING PERFORMANCE



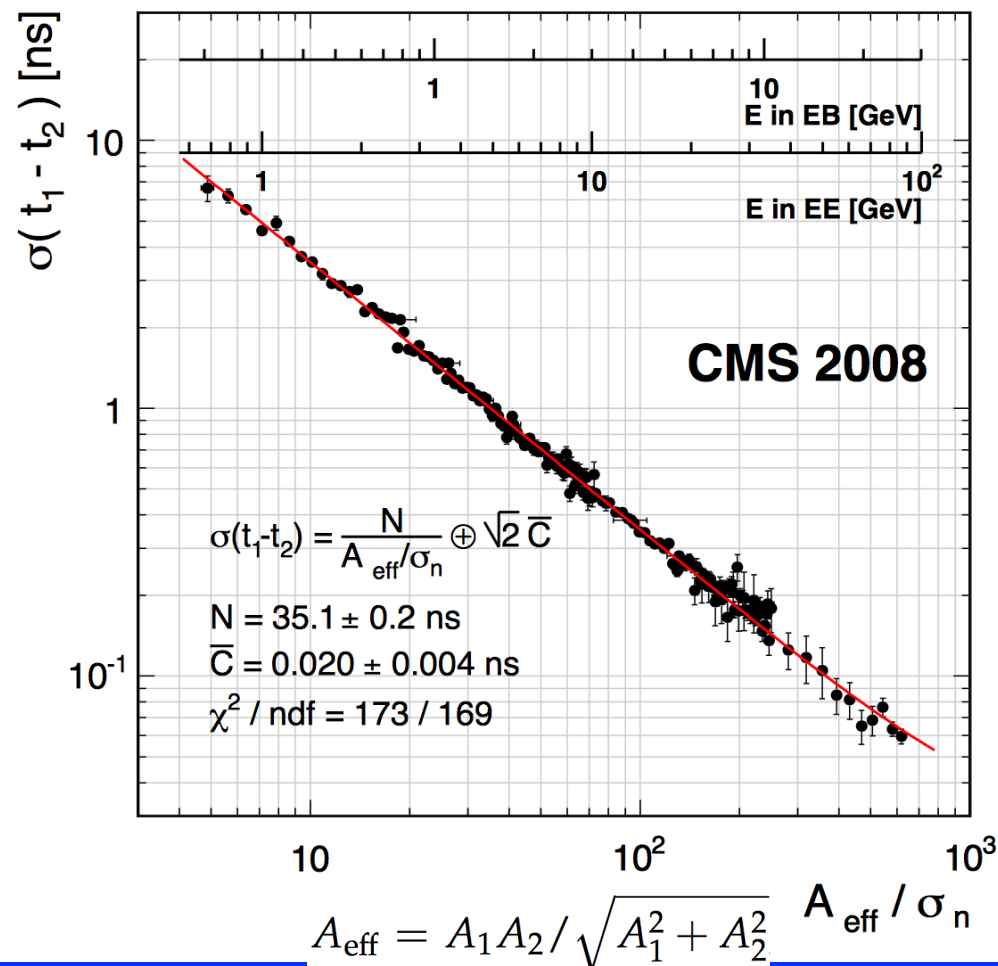
Test beam (2008)

- 2 crystals in the same EM shower: **20 ps constant term**

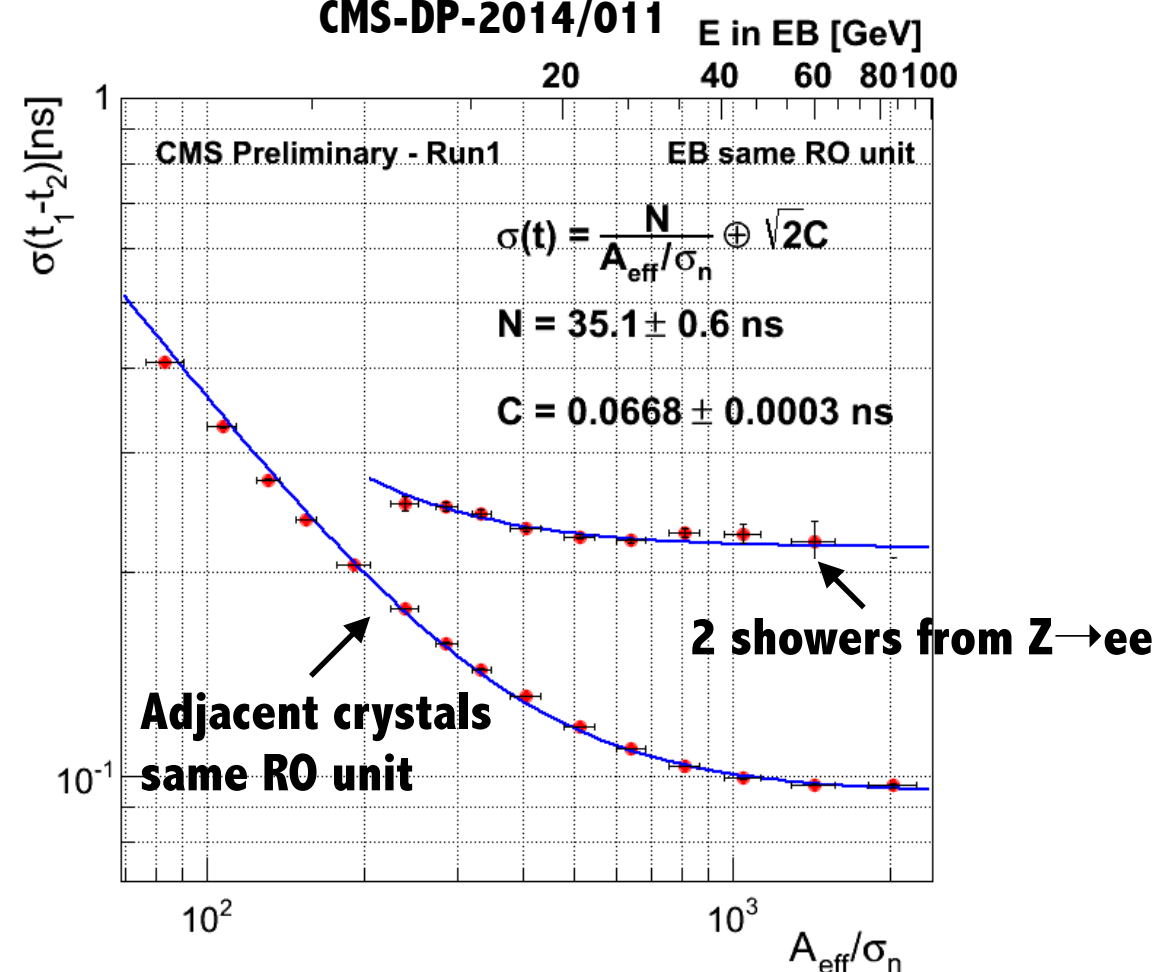
In-situ (Run1)

- 2 crystals in the same EM shower & same readout unit: **70 ps constant term**, degradation due to time calibration stability
- 2 crystals in different showers from $Z \rightarrow ee$: **150 ps constant term**, additional degradation from clock distribution

JINST 5:T03011,2010



CMS-DP-2014/011



THE HL-LHC CHALLENGE

HL-LHC (>2026): $L > 5E34 \text{cm}^{-2}\text{s}^{-1}$, $L_{\text{int}} > 300 \text{fb}^{-1} \times \text{year}$ (target 3000fb^{-1} in 10 years)

radiation 1 order of magnitude worse than current LHC conditions

140-200 interactions per bunch-crossing

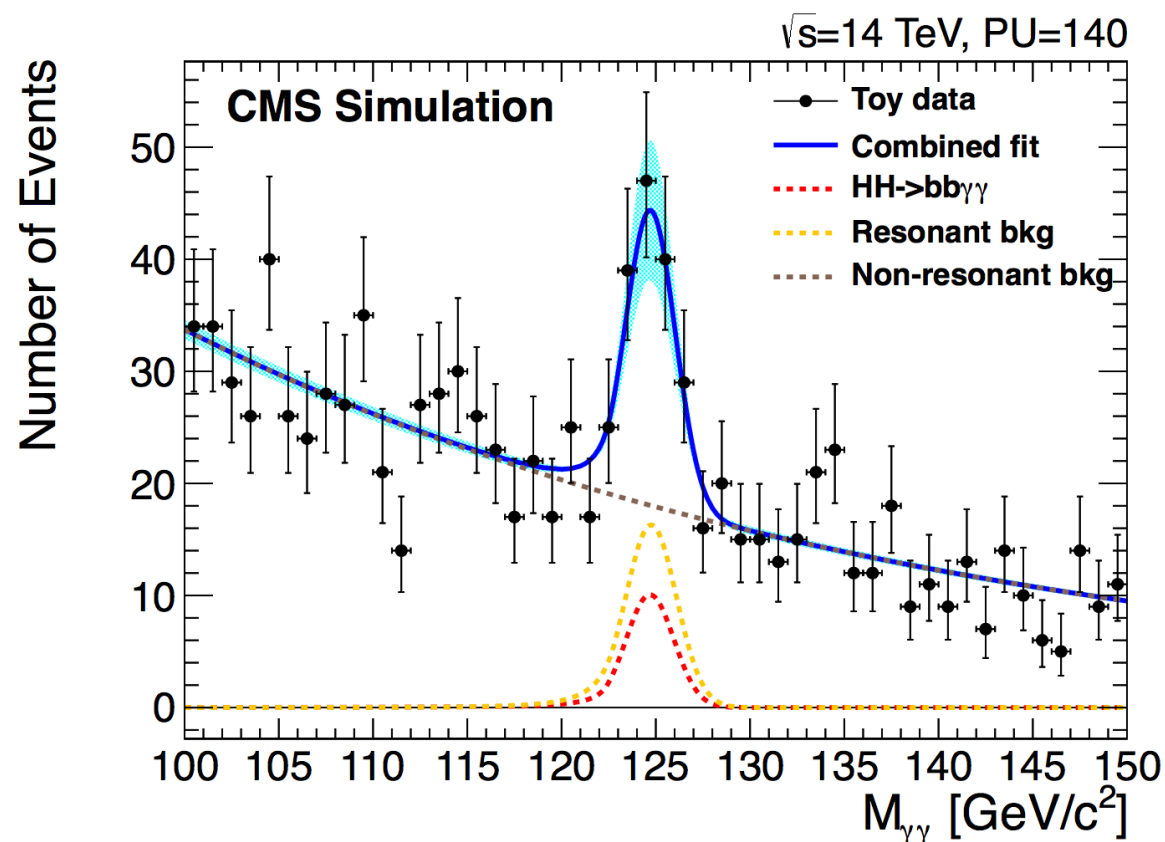
pile-up deteriorates object reconstruction: in a $\Delta R=0.4$ cone ~ 50 GeV from pile-up

HL-LHC challenge: precision physics with 200 pile-up events

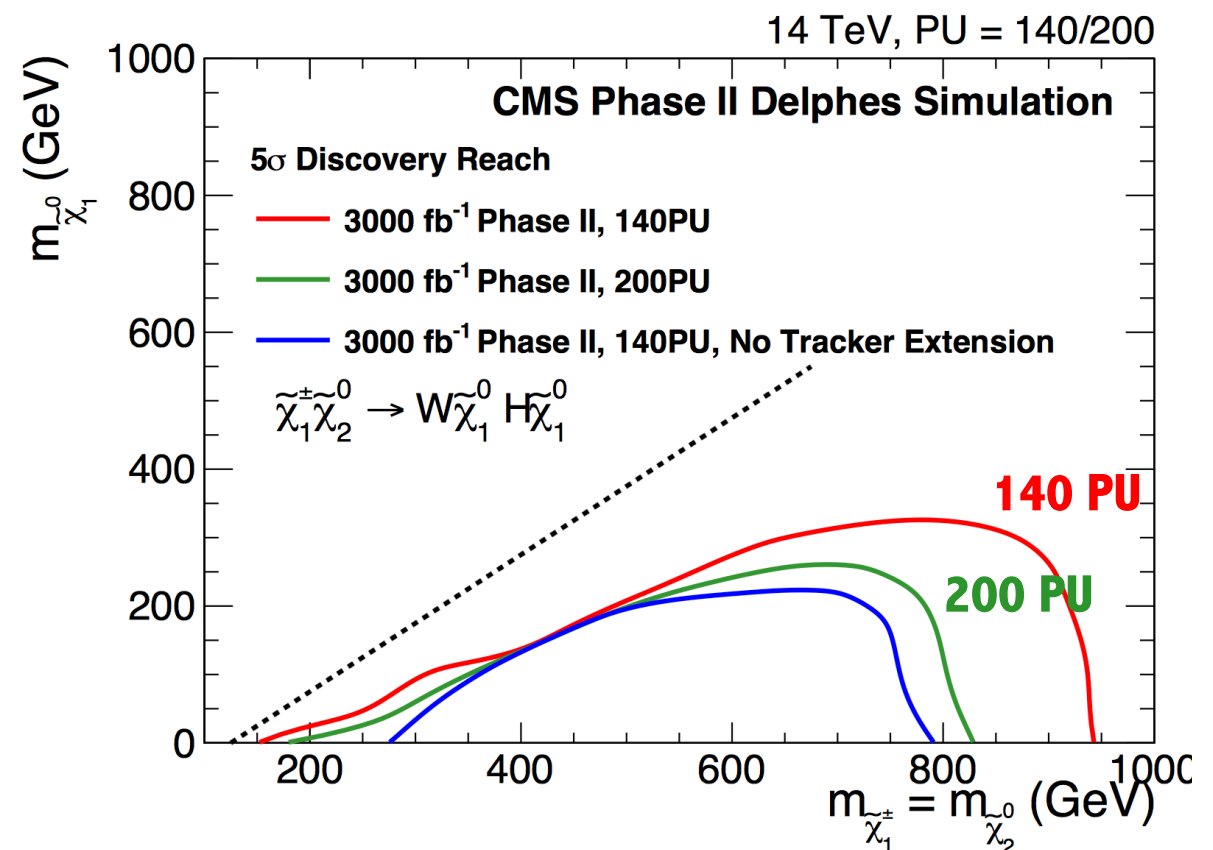
Higgs couplings precision 3-10%, access Higgs self-coupling (HH)

Extend sensitivity for BSM processes

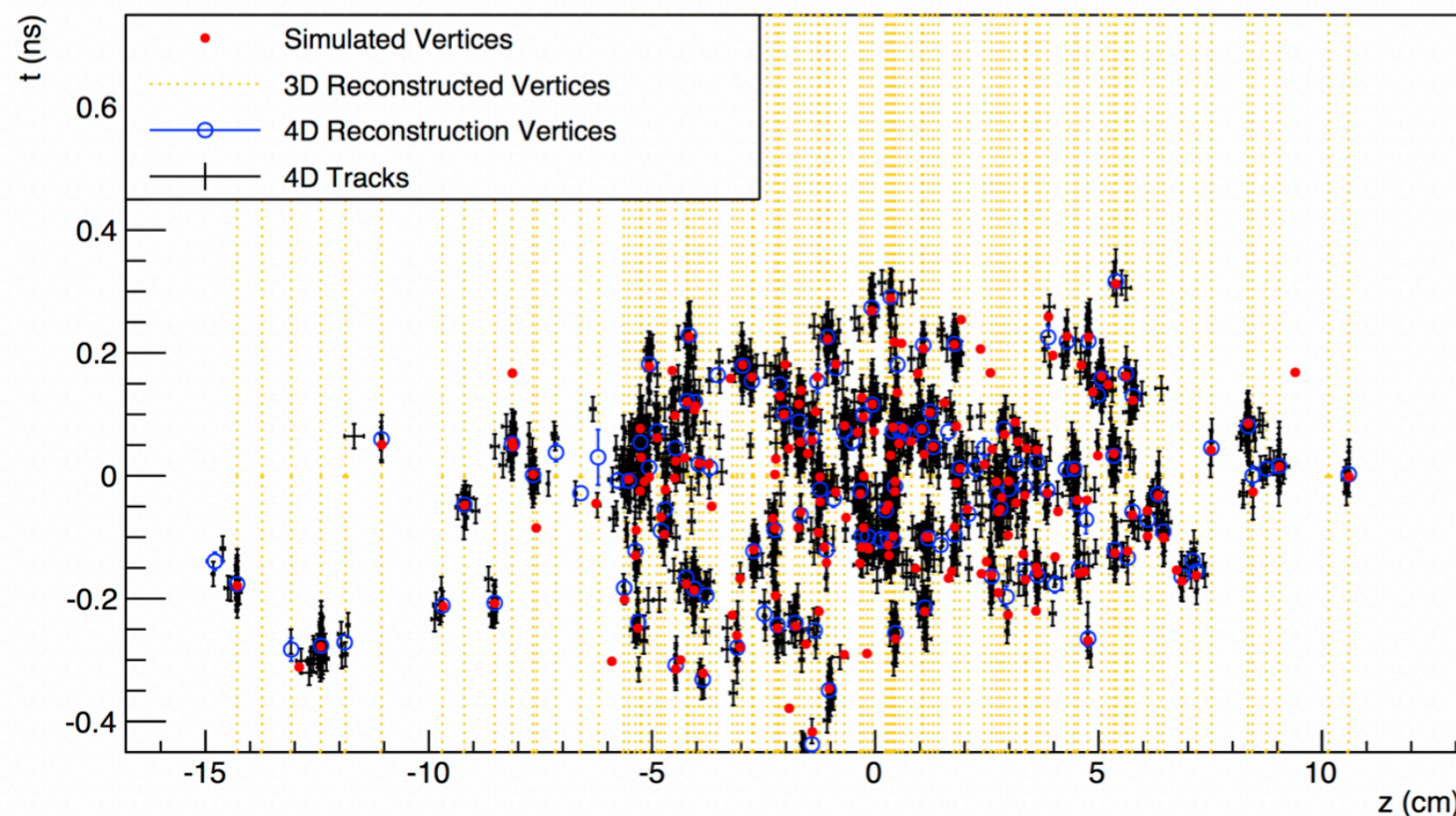
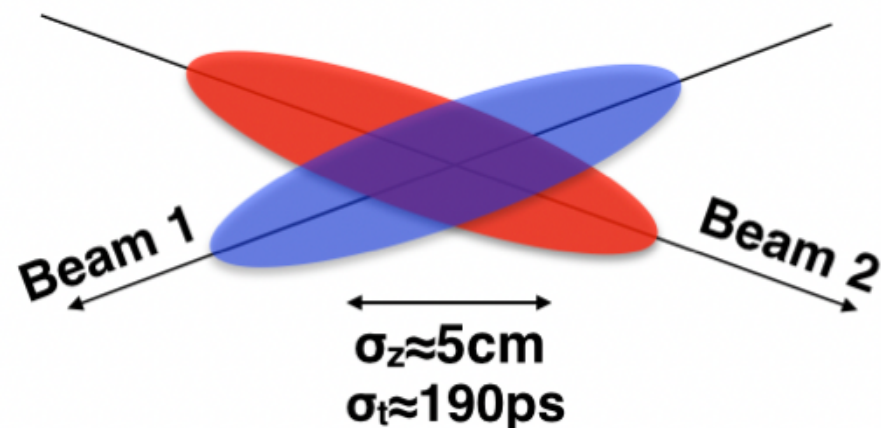
HH($bb\gamma\gamma$) @ 3000fb^{-1}



SUSY: $W^\pm H + E_T^{\text{MIS}}$



PRECISION TIMING @ HL-LHC



Pile-up vertices are spread along beam direction and time: precision timing for charged & neutral particles will be a key to reduce pile-up contamination

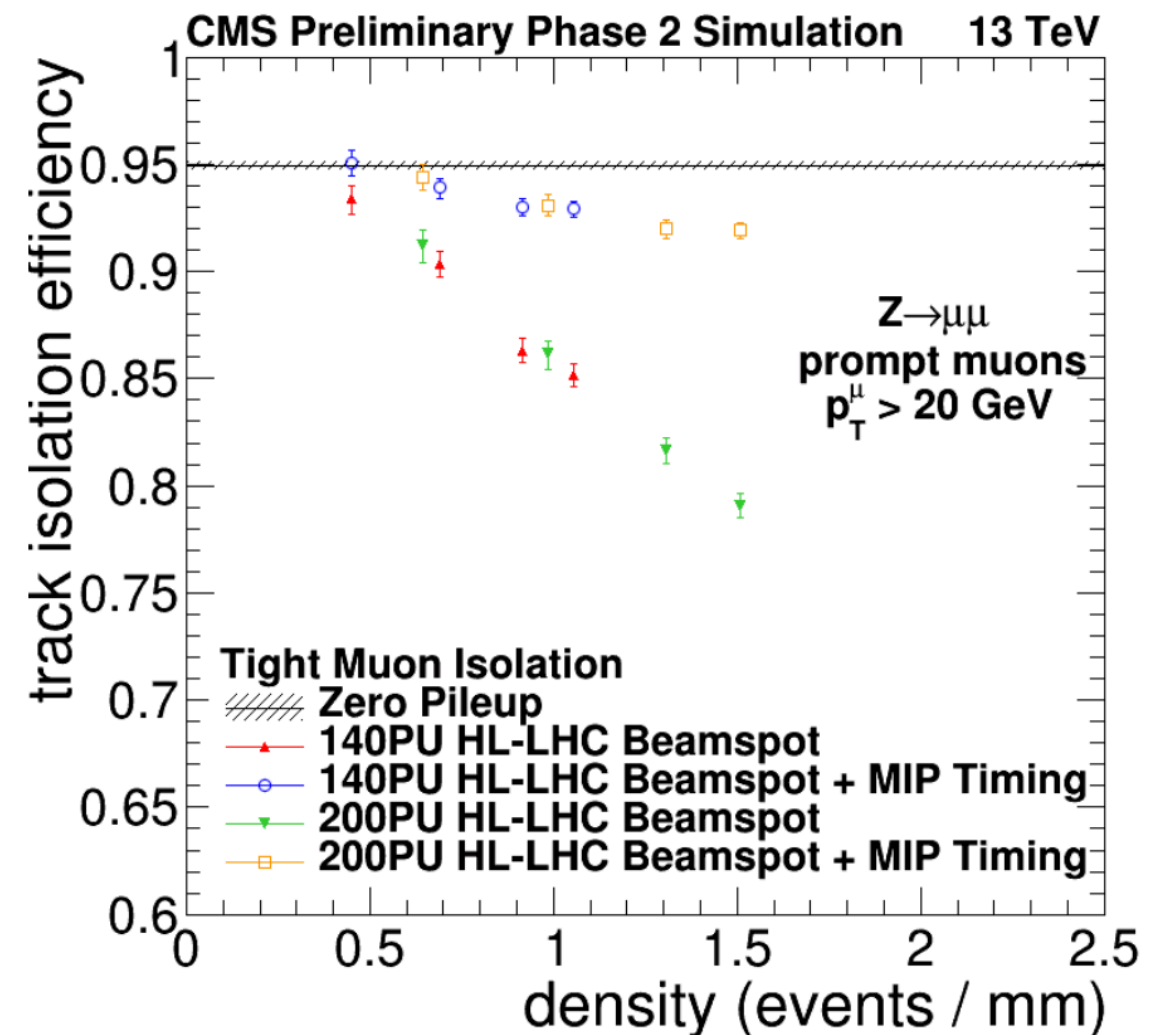
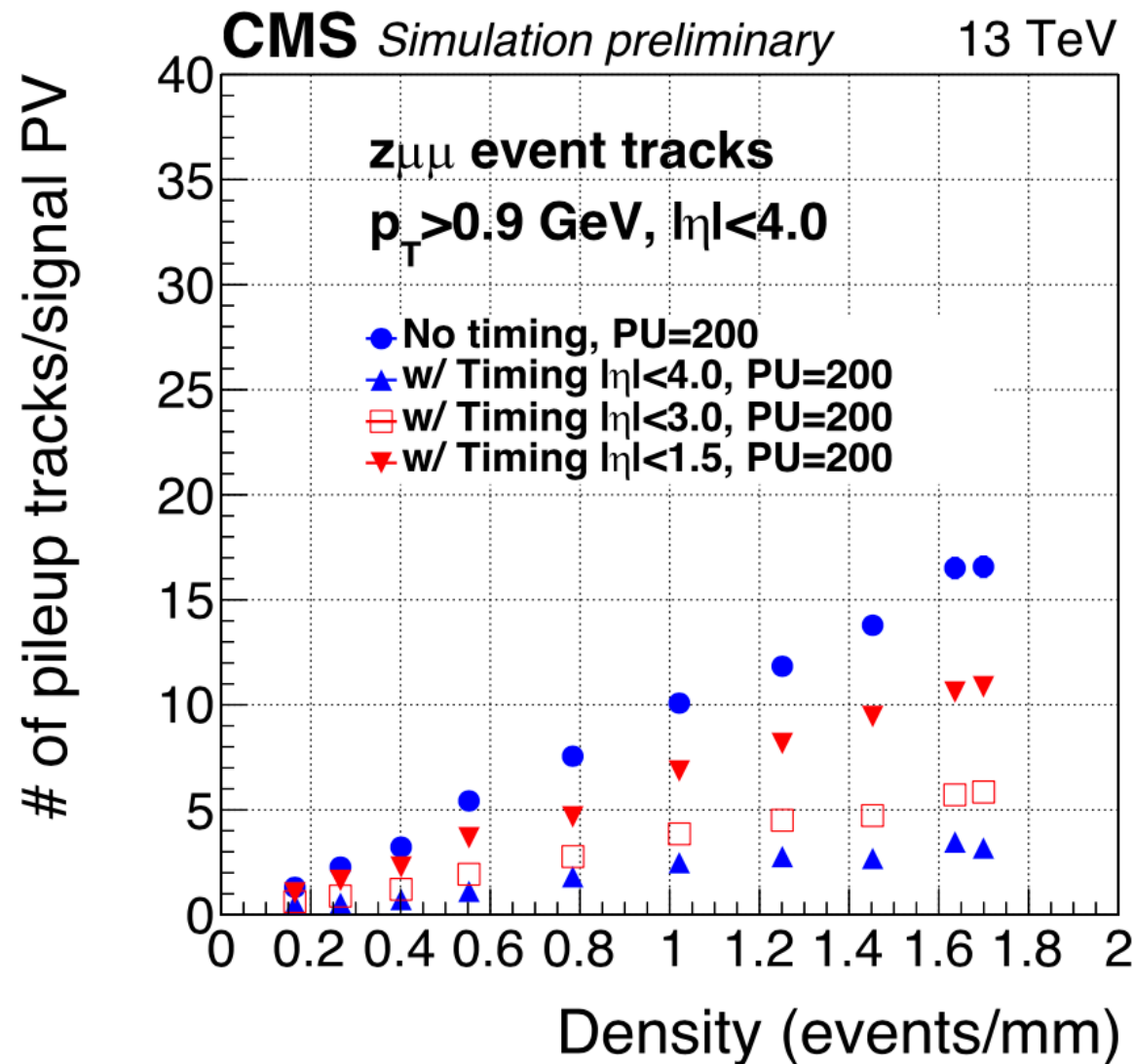
Track timing ($<30\text{ps}$) will allow full 4D (space+time) vertex reconstruction

~ x10 reduction of vertex merging rate wrt 3D reconstruction @ PU200

CMS is considering a dedicated timing layer for MIPs with hermetic coverage $|\eta| < 3$ in front of calorimeters

Thin crystals+SiPM in the barrel, Si sensors with gain in the endcaps

PRECISION TIMING & PILE-UP

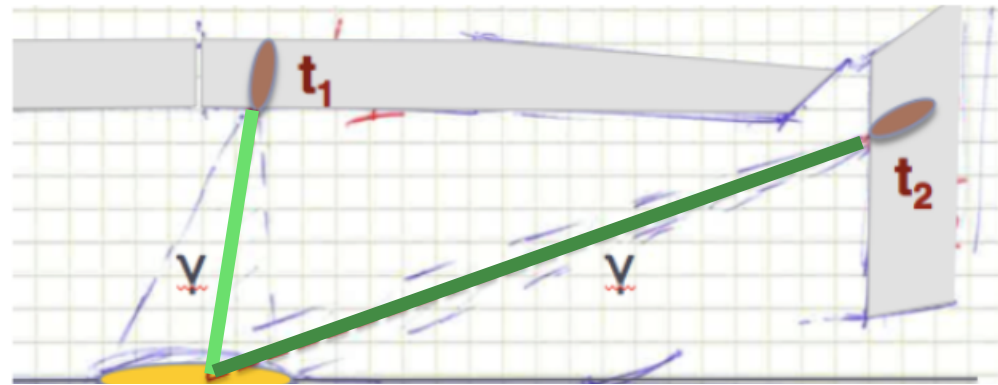


MIP Timing allows to reduce ~x5 spurious pile-up tracks

track-vertex compatibility requirements both in space and time
significant improvements for event reconstruction: isolation efficiency
(e, μ, τ, γ), jet/MET resolution

Pile-up reduction also possible for photons if similar time resolution is achieved

PHOTON TIMING & $H \rightarrow \gamma\gamma$



CMS Projection

3000 fb⁻¹ (13 TeV)

$H \rightarrow \gamma\gamma$

fiducial volume :

$$p_T^{\text{gen}}(\gamma_{1(2)}) > \frac{1}{3} \left(\frac{1}{4} \right) m_{\gamma\gamma}$$

$$|\eta^{\text{gen}}(\gamma_{1,2})| < 2.5$$

$$\text{Iso}_{R=0.3}^{\text{gen}}(\gamma_{1,2}) < 10 \text{ GeV}$$

— S2 (80% Vertex Efficiency)

— S2+ Optimistic (75% Vertex Efficiency)

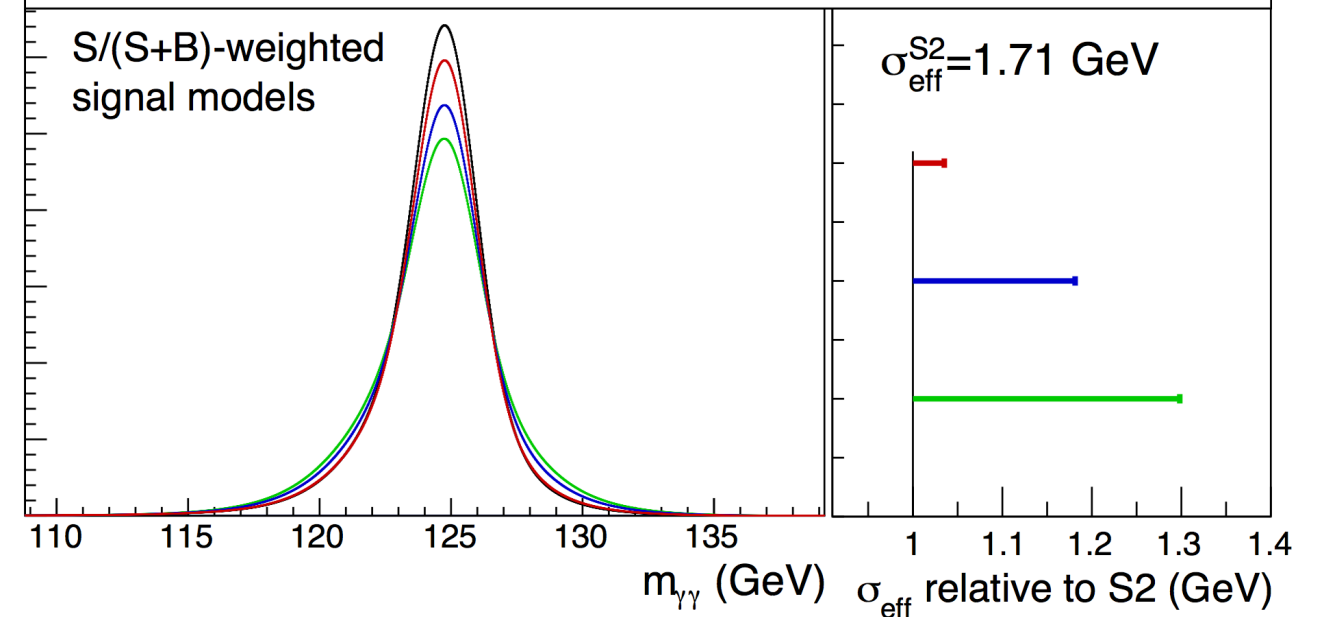
— S2+ Intermediate (55% Vertex Efficiency)

— S2+ Pessimistic (40% Vertex Efficiency)

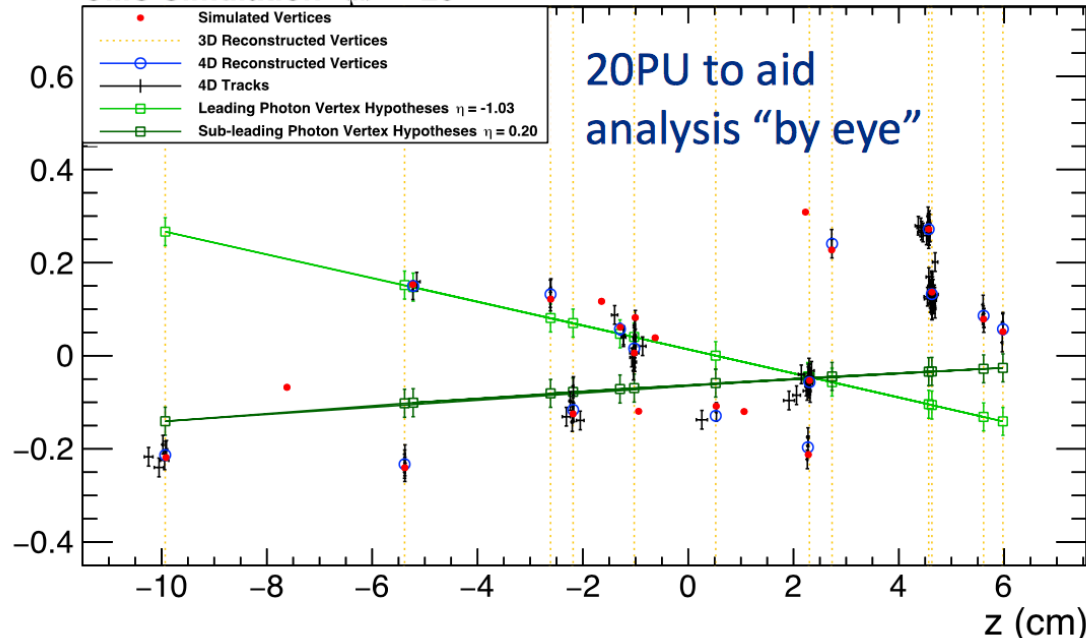
arbitrary units

S/(S+B)-weighted
signal models

$\sigma_{\text{eff}}^{\text{S2}} = 1.71 \text{ GeV}$



CMS Simulation $\langle \mu \rangle = 20$



Photon timing (<30ps) allows to determine di-photon interaction vertex position (and time)

Vertex currently determined using recoiling tracks properties. Efficiency ~80% with current pile-up LHC conditions, will become 30% @ PU200

ECAL+track precision timing allows to ~ keep current vertex efficiency @ PU200

ECAL BARREL UPGRADE



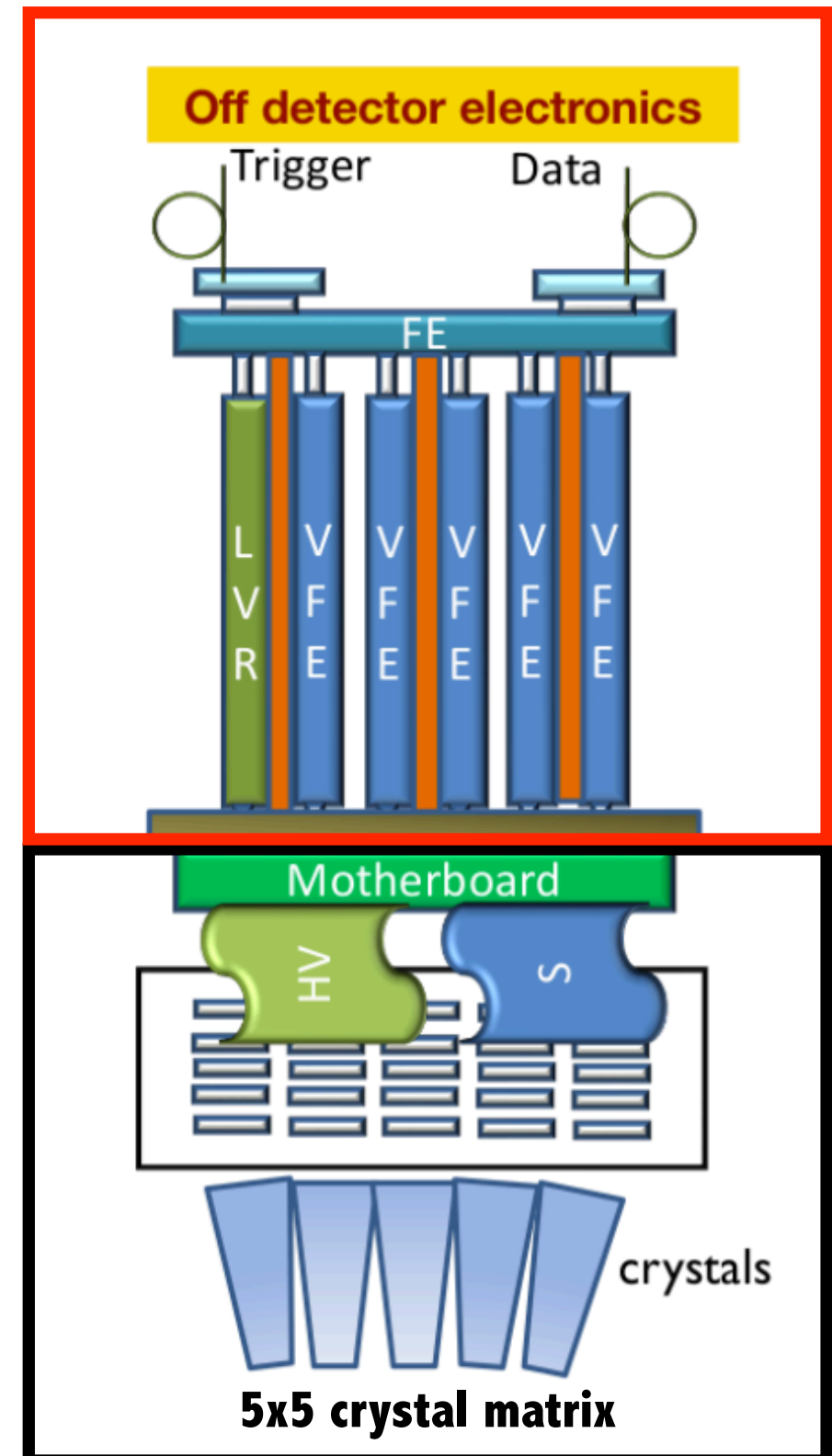
Upgrade necessary to cope with increased APD dark current, pile-up, trigger latency ($12.5\ \mu\text{s}$) and L1 accept rate ($750\ \text{kHz}$)

Operating temperature from 18°C to 9°C to reduce APD dark current

Keep crystals+APD, replace Very Front-End (VFE), FE and off-detector electronics

Profit of ECAL electronics replacement to optimise precision timing capabilities

goal is to reach a time resolution $<30\text{ps}$ for $H \rightarrow \gamma\gamma$ photons ($E > 50\ \text{GeV}$)



REPLACE

KEEP

Upgrade VFE based on dual gain Trans Impedance Amplifier (TIA)

preserve a fast signal to optimise time resolution

bandwidth cutoff (~ 35 MHz) imposed by APD/kapton impedance

allow discrimination between scintillation and signals generated by hadron interactions in the APD (spike)

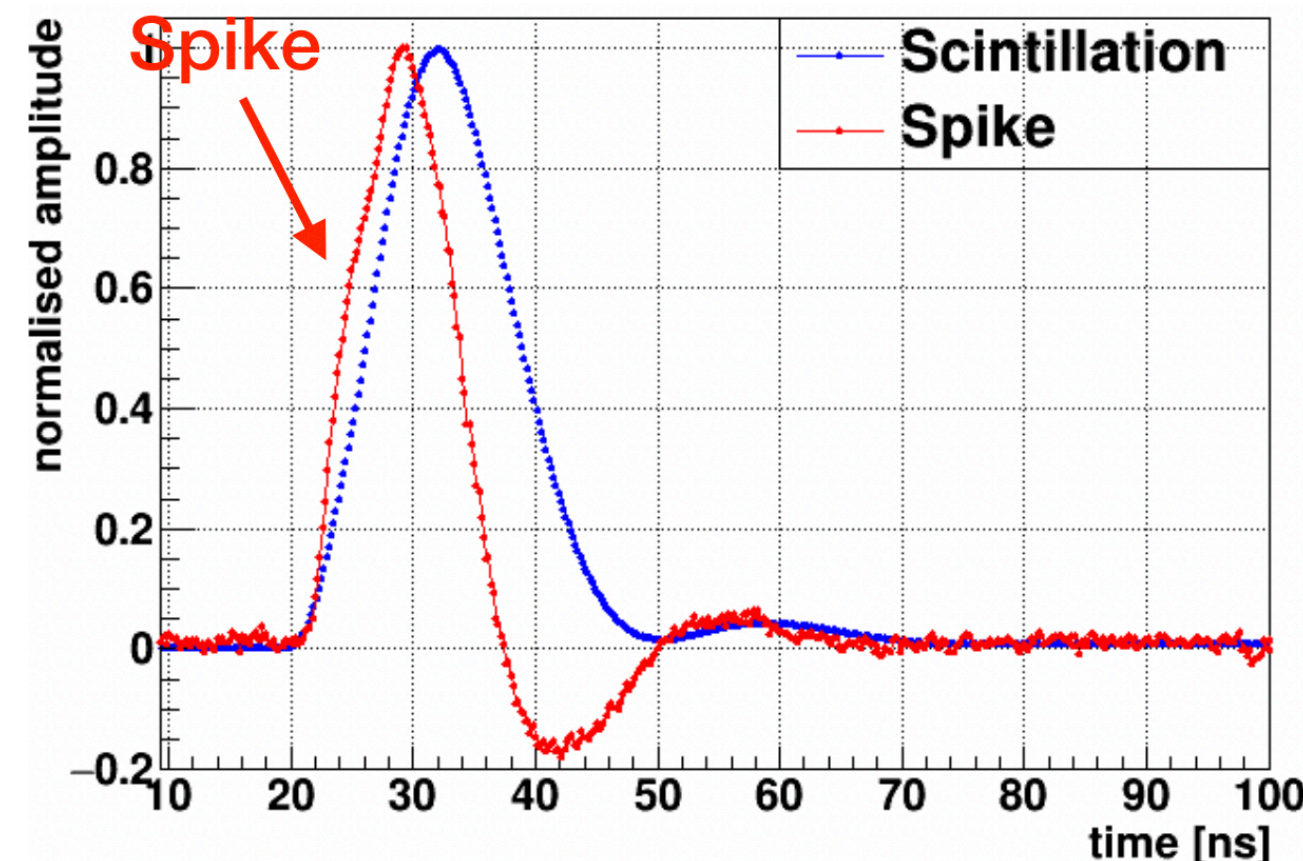
ADC sampling rate increased @ 160 MHz

samples shipped to off detector electronics using high-speed optical links

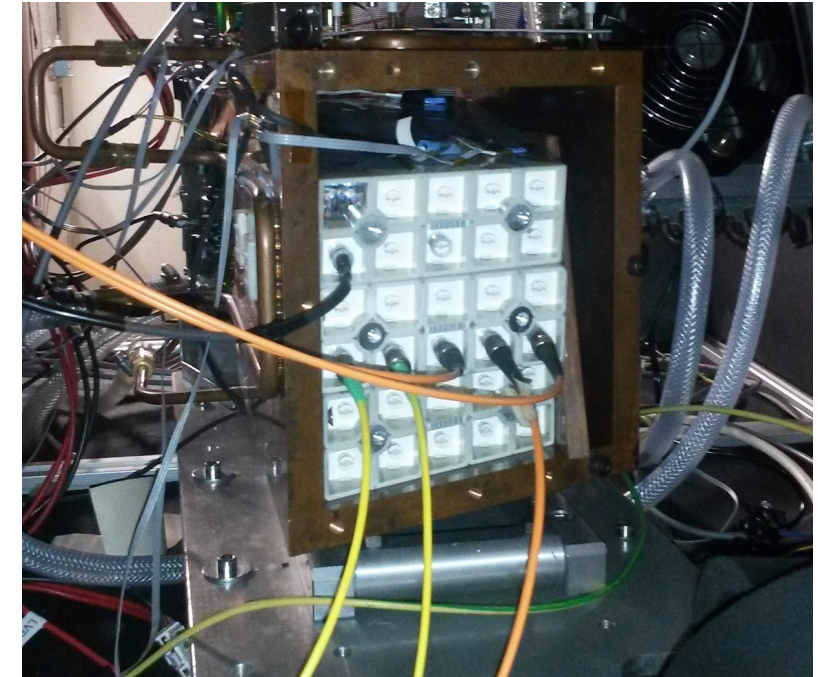
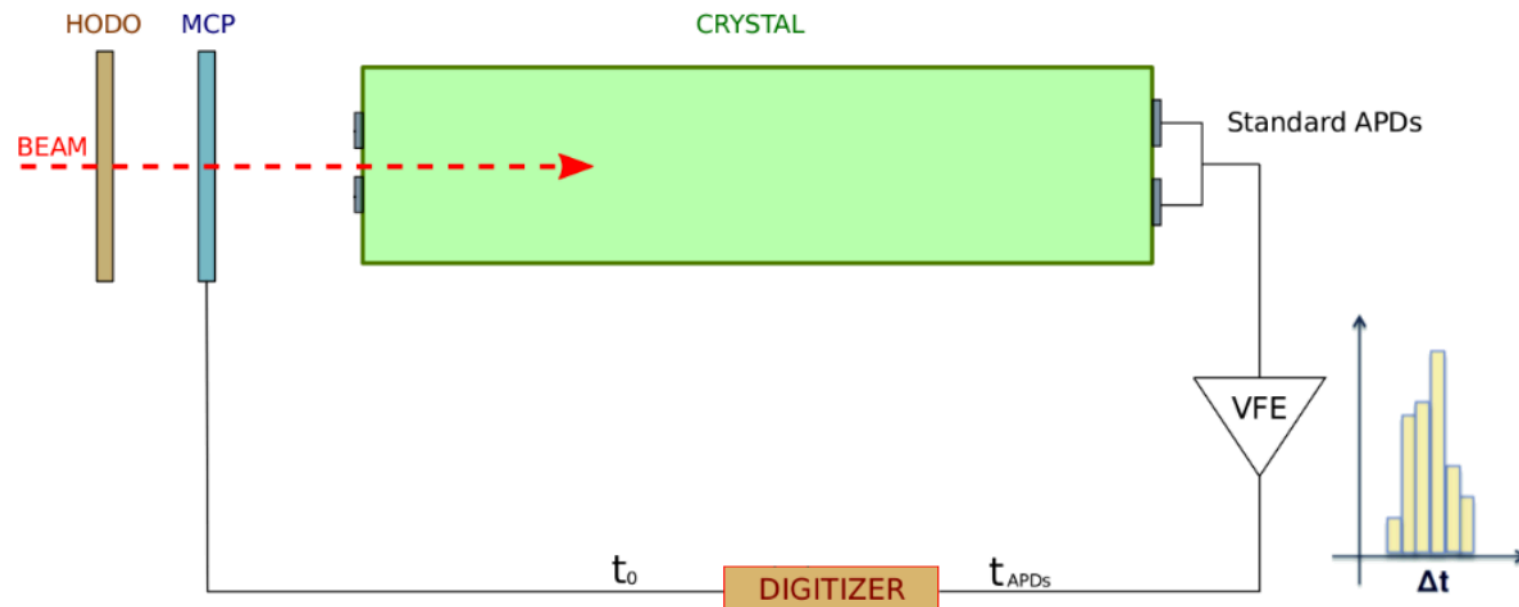
Clock distribution has a crucial role

need to ensure clock stability < 10 ps on a large distributed system

**pulse shape in test beam with TIA
(discrete components)**



TEST BEAM STUDIES



Test beams performed in 2015,16 & 17 @ CERN SPS H4 to study intrinsic PbWO_4 timing capabilities

5x5 matrix of ECAL barrel crystals + APDs

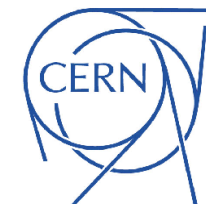
different VFE electronics configuration

signals readout by a fast digitiser (CAEN V1742 5GS/s)

time extracted from a fit to the pulse shape

Micro-Channel Plate (MCP) detectors used as time reference ($\sigma_t \sim 20$ ps)

TEST BEAM 2015

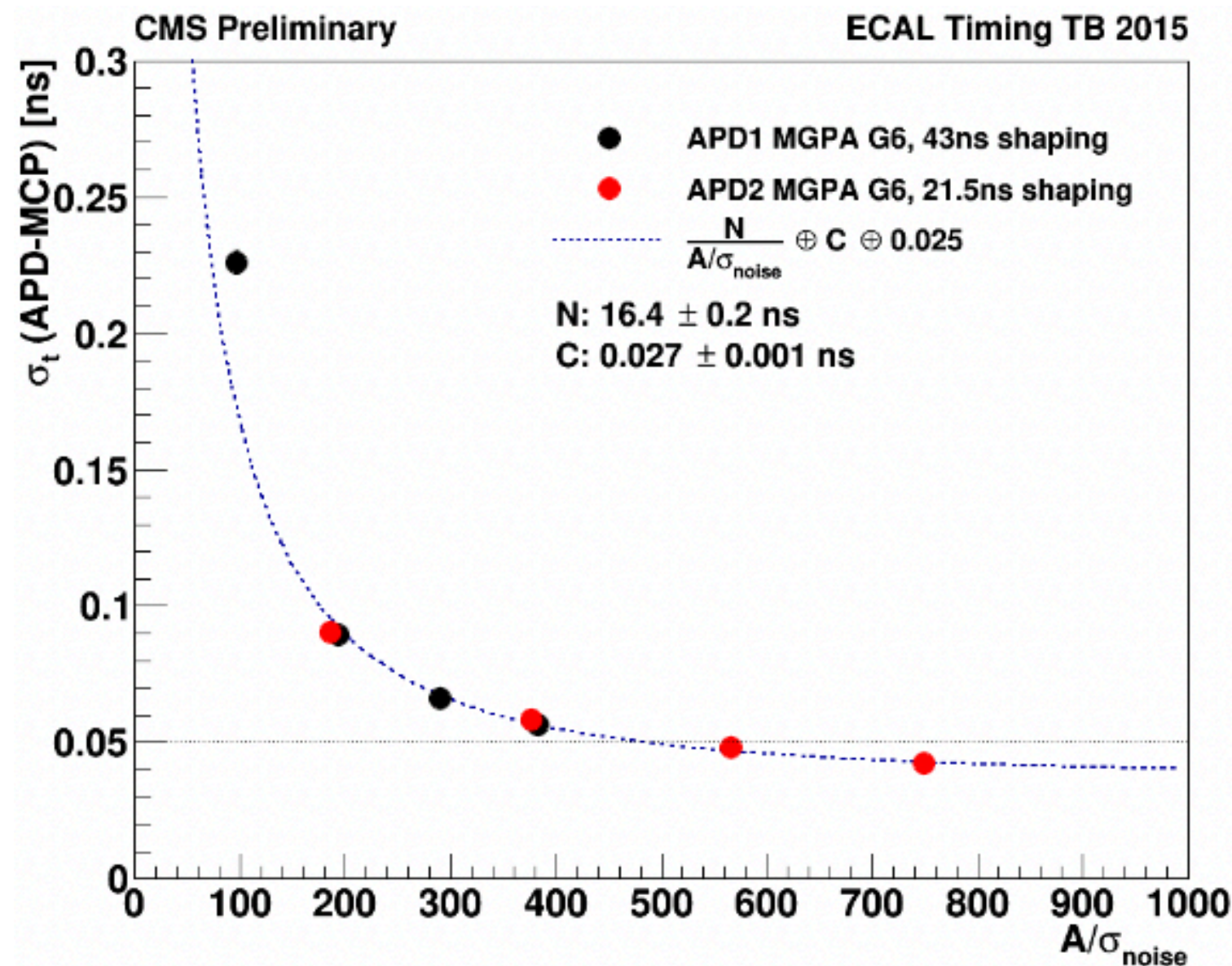


APD + VFE electronics with standard (43 ns) and reduced (21.5 ns) shaping time

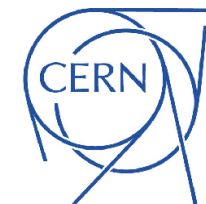
21.5 ns shaping time almost $\times 2$ A/σ_{noise}

Additional noise from test beam custom electronics

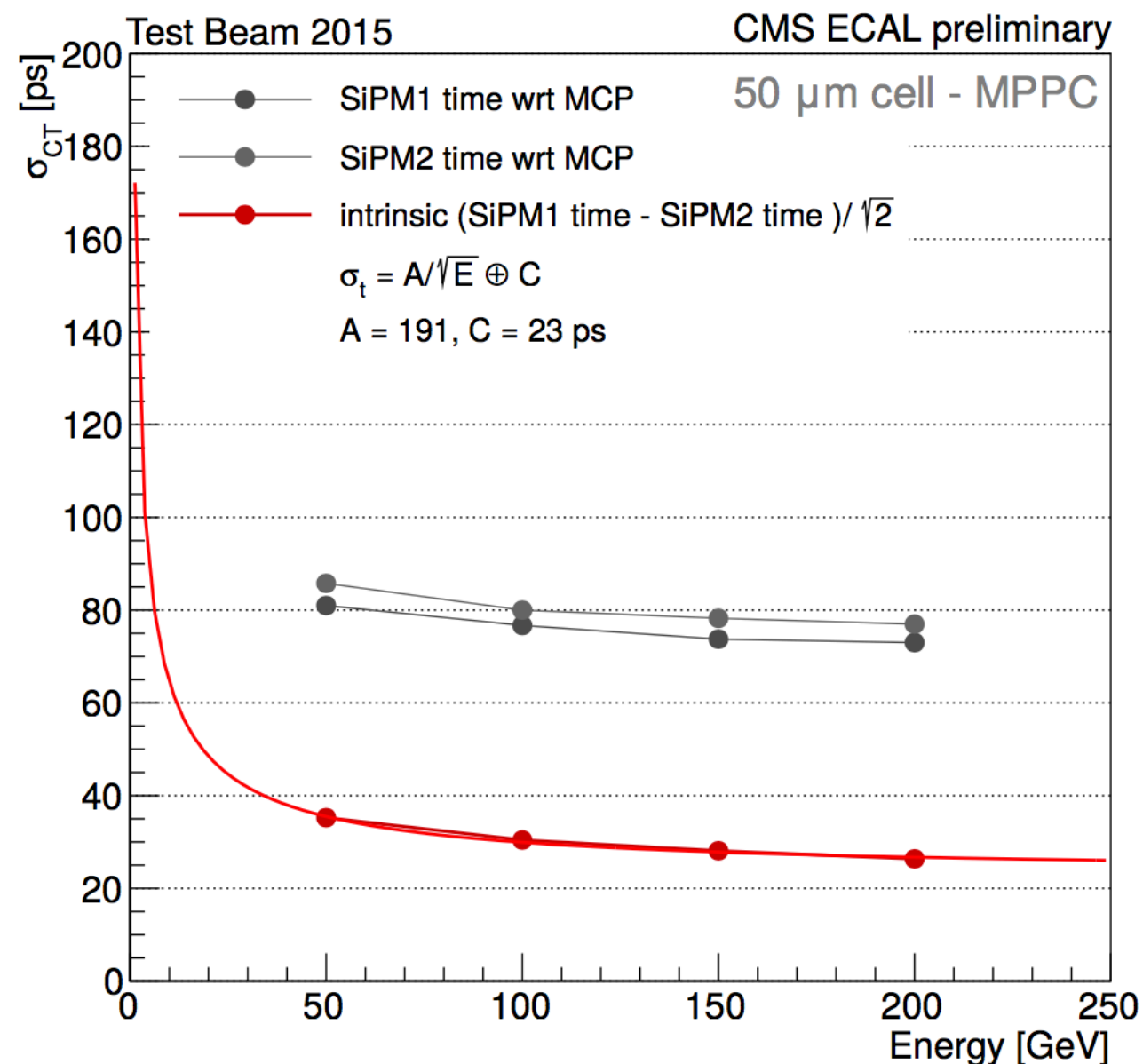
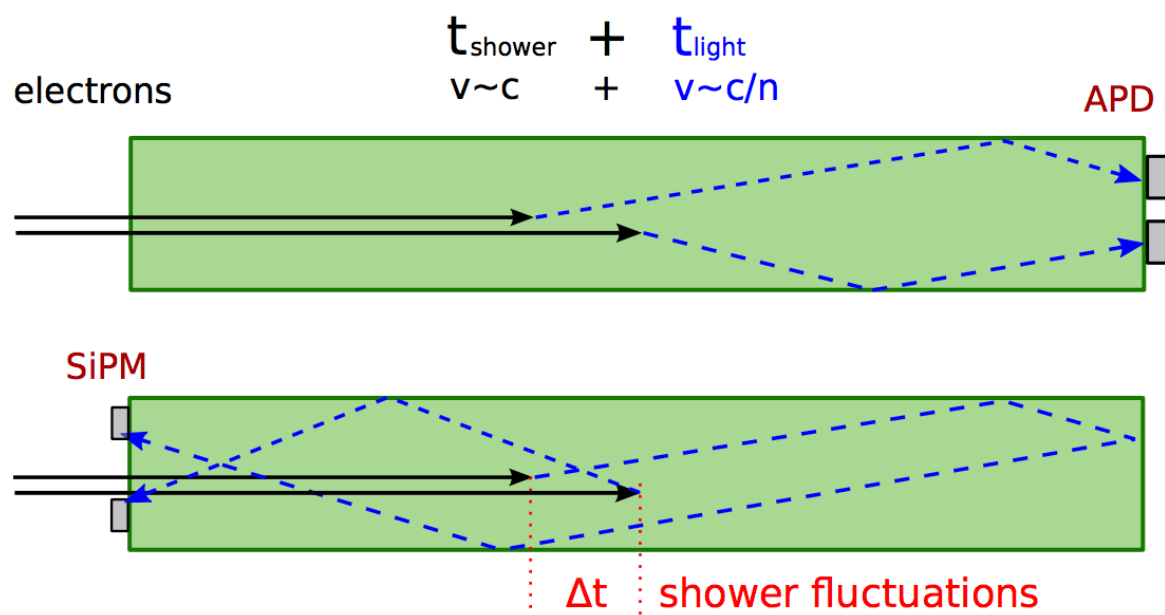
in CMS: $A/\sigma_{\text{noise}} \sim 800$ for a 50 GeV shower



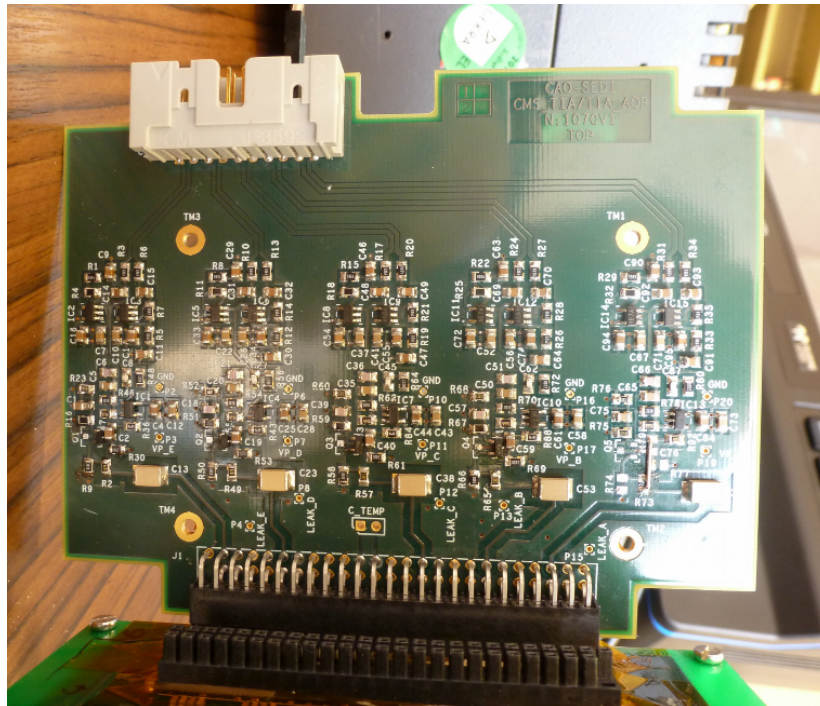
TEST BEAM 2015



Readout using 2 SiPMs from the front face
 resolution dominated by longitudinal
 shower fluctuations (~ 80 ps constant term)



TEST BEAM 2016



Prototype VFE with TIA implemented using discrete components

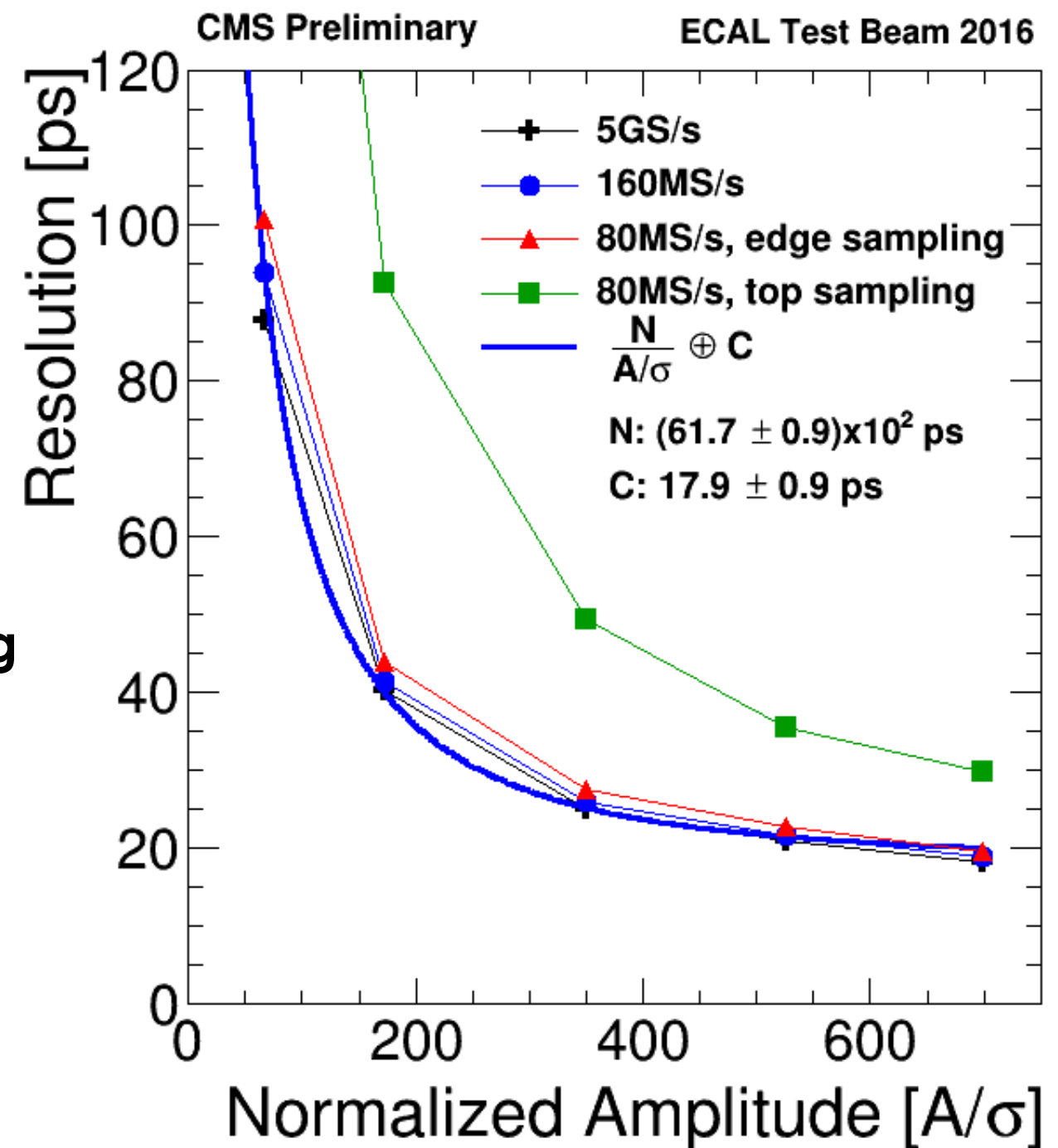
30ps resolution for $A/\sigma = 250$

25 GeV @ HL-LHC start (100 MeV noise)

60 GeV @ HL-LHC end (240 MeV noise)

Optimal performance already with 160 MHz sampling

Test beam with prototype TIA ASIC + integrated ADC in October



Precision timing will be a powerful tool to reduce pile-up contamination at HL-LHC

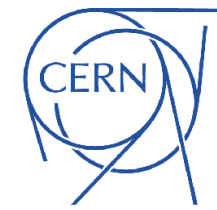
Upgraded CMS ECAL will enhance the timing performance to $<30\text{ps}$ for $H \rightarrow \gamma\gamma$ photons

Prototypes tested in high energy beams meet specifications. Further tests are on-going

Additional capabilities of charged + neutrals timing @ HL-LHC with CMS are being investigated

BACK-UP

CMS HL-LHC UPGRADE PLAN



Tracker

Coverage up to $|\eta| \sim 4$
Increased granularity
Tracks in L1 trigger

Muons

Complete coverage in fwd region
 $|\eta| > 1.6$ (new GEM/RPC technology)
Investigate muon tagging up to
 $|\eta| \sim 3$

Trigger

L1 with tracks, 750 kHz,
latency $\geq 12.5 \mu\text{s}$

Barrel calorimeters

New readout electronics

Endcap calorimeters

New high granularity calorimeter

